

Vishay Siliconix

# P-Channel 30 V (D-S) MOSFET



PRODUCT SUMMARY						
V <sub>DS</sub> (V)	-30					
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = -10 \text{ V}$	0.0240					
$R_{DS(on)}$ max. ( $\Omega$ ) at $V_{GS} = -4.5 \text{ V}$	0.0350					
Q <sub>g</sub> typ. (nC)	15					
I <sub>D</sub> (A) <sup>d</sup>	-11.4					
Configuration	Single					

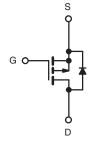
#### **FEATURES**

- TrenchFET® power MOSFET
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



#### **APPLICATIONS**

- · Load switches
- · Battery switch



P-Channel MOSFET

ORDERING INFORMATION				
Package	SO-8			
Lead (Pb)-free	Si4435DDY-T1-E3			
Lead (Pb)-free and halogen-free	Si4435DDY-T1-GE3			

PARAMETER	SYMBOL	LIMIT	UNIT		
Drain-source voltage		V <sub>DS</sub>	-30		
Gate-source voltage		V <sub>GS</sub>	± 20	V	
	T <sub>C</sub> = 25 °C		-11.4		
Ocation and design and (T. 150 %O)	T <sub>C</sub> = 70 °C	1.	-9.1		
Continuous drain current (T <sub>J</sub> = 150 °C)	T <sub>A</sub> = 25 °C	I <sub>D</sub>	-8.1 <sup>a, b</sup>		
	T <sub>A</sub> = 70 °C	1	-6.5 <sup>a, b</sup>	1	
Pulsed drain current	I <sub>DM</sub>	-50	A		
	T <sub>C</sub> = 25 °C	- I <sub>S</sub>	-4.1		
Continuous source-drain diode current	T <sub>A</sub> = 25 °C		-2 <sup>a, b</sup>		
Avalanche current	. 0.111	I <sub>AS</sub>	-20		
Single-pulse avalanche energy	L = 0.1 mH	E <sub>AS</sub>	20	mJ	
Maximum power dissipation	T <sub>C</sub> = 25 °C		5		
	T <sub>C</sub> = 70 °C	P <sub>D</sub>	3.2	٦,,,	
	T <sub>A</sub> = 25 °C		2.5 <sup>a, b</sup>	W	
	T <sub>A</sub> = 70 °C	1	1.6 <sup>a, b</sup>	1	
Operating junction and storage temperature range	T <sub>J</sub> , T <sub>stq</sub>	-55 to +150	°C		

THERMAL RESISTANCE RATINGS					
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT
Maximum junction-to-ambient a, c	t ≤ 10 s	$R_{thJA}$	38	50	°C/W
Maximum junction-to-foot	Steady state	$R_{thJF}$	20	25	C/ VV

#### Notes

- a. Surface mounted on 1" x 1" FR4 board
- b. t = 10 s
- c. Maximum under steady state conditions is 85 °C/W
- d. Based on  $T_C = 25\ ^{\circ}C$

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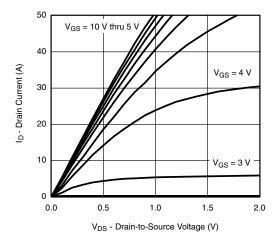
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static				•			
Drain-source breakdown voltage	$V_{DS}$	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$	-30	-	-	V	
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	I 050 A	-	-31	-	mV/°C	
V <sub>GS(th)</sub> temperature coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = -250 μA	-	4.5	-		
Gate-source threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	-1	-	-3	V	
Gate-source leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$	-	-	± 100	nA	
Zana mata walta na disaha awamant		V <sub>DS</sub> = -30 V, V <sub>GS</sub> = 0 V	-	-	-1	1 .	
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> = -30 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 55 °C	-	-	-5	μA	
On-state drain current a	I <sub>D(on)</sub>	$V_{DS} \ge -10 \text{ V}, V_{GS} = -10 \text{ V}$	-30	-	-	Α	
Duning and the seriet and 3	Б	V <sub>GS</sub> = -10 V, I <sub>D</sub> = -9.1 A	-	0.0195	0.0240	1 -	
Drain-source on-state resistance <sup>a</sup>	R <sub>DS(on)</sub>	$V_{GS} = -4.5 \text{ V}, I_D = -6.9 \text{ A}$	-	0.0280	0.0350	Ω	
Forward transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = -10 V, I <sub>D</sub> = -9.1 A	-	23	-	S	
Dynamic <sup>b</sup>			•				
Input capacitance	C <sub>iss</sub>		-	1350	-	pF	
Output capacitance	C <sub>oss</sub>	V <sub>DS</sub> = -15 V, V <sub>GS</sub> = 0 V, f = 1 MHz	-	215	-		
Reverse transfer capacitance	C <sub>rss</sub>		-	185	-		
Total gate charge	$Q_g \qquad V_{DS} = -15 \text{ V}, V_{GS} = -15 \text{ V}$	V <sub>DS</sub> = -15 V, V <sub>GS</sub> = -10 V, I <sub>D</sub> = -9.1 A	-	32	50	5	
			-	15	25		
Gate-source charge	Q <sub>gs</sub>	$V_{DS} = -15 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -9.1 \text{ A}$	-	4	-	nC	
Gate-drain charge	Q <sub>ad</sub>		-	7.5	-		
Gate resistance	R <sub>a</sub>	f = 1 MHz	-	5.8	-	Ω	
Turn-on delay time	t <sub>d(on)</sub>		-	10	15		
Rise time	t <sub>r</sub>	$V_{DD} = -15 \text{ V}, R_{L} = 15 \Omega$	-	8	15		
Turn-off delay time	t <sub>d(off)</sub>	$I_D \cong -1 \text{ A}, V_{GEN} = -10 \text{ V}, R_g = 1 \Omega$	-	45	70		
Fall time	t <sub>f</sub>		-	12	25		
Turn-on delay time	t <sub>d(on)</sub>		-	42	70	ns	
Rise time	t <sub>r</sub>	$V_{DD} = -15 \text{ V}, R_1 = 15 \Omega$	-	35	60		
Turn-off delay time	t <sub>d(off)</sub>	$I_D \cong -1$ A, $V_{GEN} = -4.5$ V, $R_g = 1$ $\Omega$	-	40	70		
Fall time	t <sub>f</sub>		-	16	30		
<b>Drain-Source Body Diode Characteris</b>	tics			1			
Continuous source-drain diode current	I <sub>S</sub>	T <sub>C</sub> = 25 °C	-	-	-4.1		
Pulse diode forward current	I <sub>SM</sub>		-	-	-50	Α	
Body diode voltage	V <sub>SD</sub>	I <sub>S</sub> = -2 A, V <sub>GS</sub> = 0 V	-	-0.75	-1.2	V	
Body diode reverse recovery time	t <sub>rr</sub>	3 . 40	_	34	60	ns	
Body diode reverse recovery charge	Q <sub>rr</sub>	I <sub>F</sub> = -2 A, di/dt = 100 A/μs,	_	22	40	nC	
Reverse recovery fall time	t <sub>a</sub>	$T_J = 25 ^{\circ}\text{C}$	-	11	-		
Reverse recovery rise time	t <sub>b</sub>	· ·	<u> </u>	23	_	ns	

#### Notes

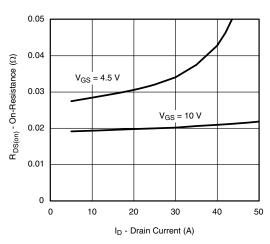
- a. Pulse test; pulse width  $\leq$  300  $\mu$ s, duty cycle  $\leq$  2 %
- b. Guaranteed by design, not subject to production testing

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

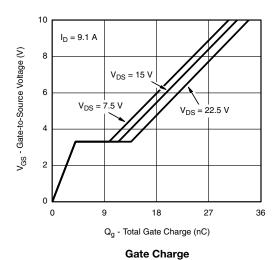


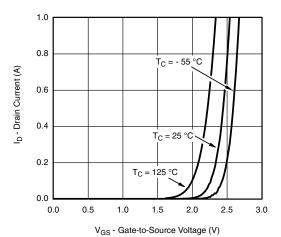


#### **Output Characteristics**

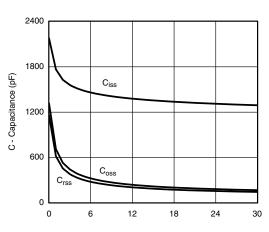


#### On-Resistance vs. Drain Current



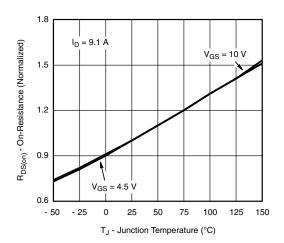


#### **Transfer Characteristics**



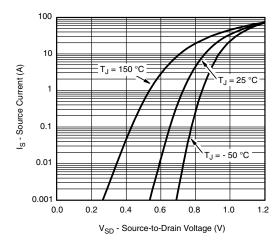
V<sub>DS</sub> - Drain-to-Source Voltage (V)

#### Capacitance

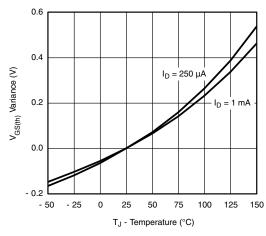


On-Resistance vs. Junction Temperature

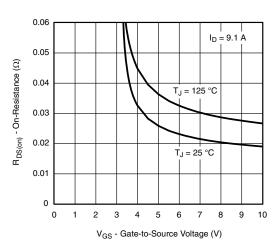




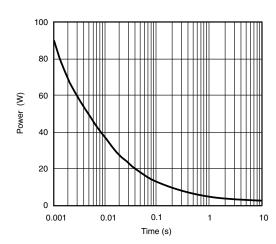
#### Source-Drain Diode Forward Voltage



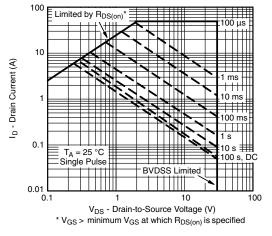
**Threshold Voltage** 



On-Resistance vs. Gate-to-Source Voltage

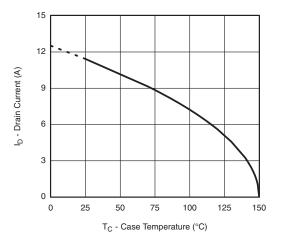


Single Pulse Power, Junction-to-Ambient

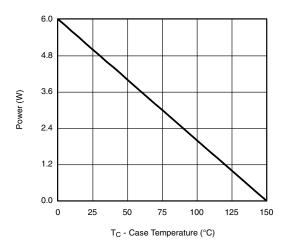


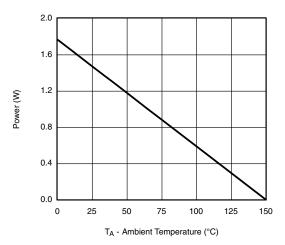
Safe Operating Area





Current Derating a





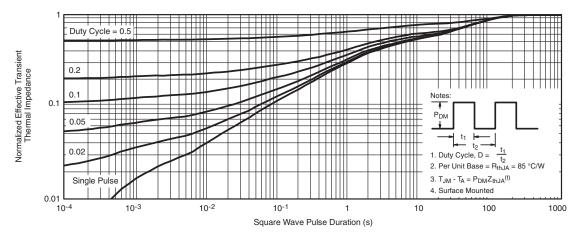
Power, Junction-to-Foot

Power Derating, Junction-to-Ambient

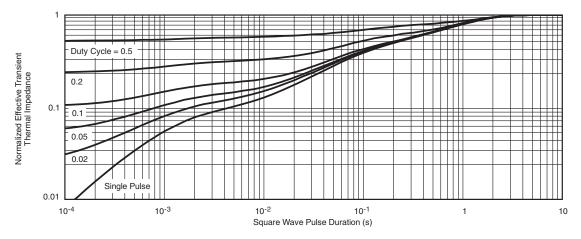
#### Note

a. The power dissipation  $P_D$  is based on  $T_J$  max. = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.





Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

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SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012







	MILLIM	IETERS	INCHES			
DIM	Min	Max	Min	Max		
Α	1.35	1.75	0.053	0.069		
A <sub>1</sub>	0.10	0.20	0.004	0.008		
В	0.35	0.51	0.014	0.020		
С	0.19	0.25	0.0075	0.010		
D	4.80	5.00	0.189	0.196		
Е	3.80	4.00	0.150	0.157		
е	1.27	BSC	0.050 BSC			
Н	5.80	6.20	0.228	0.244		
h	0.25	0.50	0.010	0.020		
L	0.50	0.93	0.020	0.037		
q	0°	8°	0°	8°		
S	0.44	0.64	0.018	0.026		
ECN: C-06527-Rev. I. 11-Sep-06						

DWG: 5498

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# LON NOTE



### **RECOMMENDED MINIMUM PADS FOR SO-8**



Recommended Minimum Pads Dimensions in Inches/(mm)

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